

Giant magnetoimpedance effect in $\text{Co}_{70}\text{Fe}_5\text{Si}_{15}\text{B}_{10}$ and $\text{Co}_{70}\text{Fe}_5\text{Si}_{15}\text{Nb}_{2.2}\text{Cu}_{0.8}\text{B}_7$ ribbons

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Abstract: Giant magnetoimpedance (GMI) effect has been observed in $\text{Co}_{70}\text{Fe}_5\text{Si}_{15}\text{B}_{10}$ and $\text{Co}_{70}\text{Fe}_5\text{Si}_{15}\text{Nb}_{2.2}\text{Cu}_{0.8}\text{B}_7$ melt-spun amorphous ribbons. The magnetoimpedance (MI) of these samples has been studied up to a frequency of 10 MHz and varying a dc magnetic field (H_{dc}) within 150 Oe. A maximum change of 89% in MI has been observed for $\text{Co}_{70}\text{Fe}_5\text{Si}_{15}\text{Nb}_{2.2}\text{Cu}_{0.8}\text{B}_7$ composition around a frequency of 3.1 MHz. Substitution of Cu and Nb for B in an initial $\text{Co}_{70}\text{Fe}_5\text{Si}_{15}\text{B}_{10}$ composition forming the $\text{Co}_{70}\text{Fe}_5\text{Si}_{15}\text{Nb}_{2.2}\text{Cu}_{0.8}\text{B}_7$ composition not only favors the GMI effect but also gives rise to the sensitivity of the magnetic response (18%/Oe), which is very beneficial for magnetic sensors applications. The GMI effect for both samples annealed at 550 K is further enhanced due to the presence of the ultrasoft magnetic materials, compared to their as-quenched samples.

Author Keywords: Co-based amorphous alloys; Magnetic sensing sensors; Magnetoimpedance effect; Proper heat treatments

Index Keywords: Amorphous alloys; Electric conductivity of solids; Giant magnetoresistance; Magnetic fields; Magnetic hysteresis; Magnetometers; Nanostructured materials; Quenching; Soft magnetic materials; X ray diffraction analysis; Giant magnetoimpedance effect; Magnetic sensor; Ultrasoft magnetic material; Cobalt alloys

Year: 2003

Source title: Japanese Journal of Applied Physics, Part 1: Regular Papers and Short Notes and Review Papers

Volume: 42

Issue: 9:00 AM

Page : 5571-5574

Cited by: 5

Link: [Scopus Link](#)

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ISSN: 214922

CODEN: JAPND

Language of Original Document: English

Abbreviated Source Title: Japanese Journal of Applied Physics, Part 1: Regular Papers and Short Notes and Review Papers

Document Type: Article

Source: Scopus

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